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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/015,675	12/17/2001	Isao Ota	111483	5111
25944 OLIFF & BERI	7590 04/27/201 RIDGE, PLC	EXAMINER		
P.O. BOX 3208	350	ANGADI, MAKI A		
ALEXANDRIA, VA 22320-4850			ART UNIT	PAPER NUMBER
			1713	
			NOTIFICATION DATE	DELIVERY MODE
			04/27/2010	ELECTRONIC

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

Notice of the Office communication was sent electronically on above-indicated "Notification Date" to the following e-mail address(es):

OfficeAction25944@oliff.com jarmstrong@oliff.com

	Application No.	Applicant(s)				
	10/015,675	OTA ET AL.				
Office Action Summary	Examiner	Art Unit				
	MAKI A. ANGADI	1792				
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	orrespondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING D. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period of Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim will apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONEI	l. lely filed the mailing date of this communication. (35 U.S.C. § 133).				
Status						
1)⊠ Responsive to communication(s) filed on <u>03 M</u>	larch 2010					
	action is non-final.					
<i>;</i>	· 					
·	closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.					
Disposition of Claims	Expanto Quayro, 1000 o.b. 11, 10	0 0.5. 210.				
·	н и					
4) Claim(s) 19-26,29 and 30 is/are pending in the application.						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>19-26 and 29-30</u> is/are rejected.						
7) Claim(s) is/are objected to.						
8) Claim(s) are subject to restriction and/o	8) Claim(s) are subject to restriction and/or election requirement.					
Application Papers						
9)☐ The specification is objected to by the Examiner.						
10)☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).						
11)☐ The oath or declaration is objected to by the Ex	caminer. Note the attached Office	Action or form PTO-152.				
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received.						
· · · · · · · · · · · · · · · · · · ·						
 2. Certified copies of the priority documents have been received in Application No 3. Copies of the certified copies of the priority documents have been received in this National Stage 						
application from the International Bureau (PCT Rule 17.2(a)).						
* See the attached detailed Office action for a list of the certified copies not received.						
ose the attached detailed enfor detail for a list	or the contined copies for reconve	G.				
Attachment(s)						
1) Notice of References Cited (PTO-892)	4) Interview Summary	(PTO-413)				
2) Notice of Draftsperson's Patent Drawing Review (PTO-948) Paper No(s)/Mail Date						
3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 5) Notice of Informal Patent Application 6) Other:						

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DETAILED ACTION

Continued Examination Under 37 CFR 1.114

A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 3/3/2010 has been entered.

Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C.103(a).

3. Claims 19-26 and 29-30 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tastu et al. (US 4,769,073) in view of Ashley et al. (EP 444470 A1), Aozasa (US 6,171,572 B1), Brancaleoni (US Patent No. 5,264,010) and Sakatani et al. (US Patent No. 5,804,513).

As to claims 19, 22 and 27, Tastu teaches an admixture that contains a cerium oxide and lanthanide salt and that has a pH in the range 5-10 (column 5, line 59-64 - column 8, lines 5-7). The aforementioned reads on and encompasses, a solution having a pH of 3 to 6 or 8 to 13 (col.5, lines 60-66), in claims 19, 22, 27 and 28.

Tastu also teaches an admixture with a solution of a cerium salt, an aqueous solution of a salt of at least one trivalent rare earth, which includes lanthanum, praseodymium, and neodymium (column 4, lines 14-29) and lists a composition comprising: ceric oxide, lanthanum oxide, and neodymium oxide and having a mean particle diameter of 1.5 +/- 1 I μ m, in EXAMPLE 1 (column 12, lines 13-37). Tatsu discloses ceric oxide in the form of the composition described in French Pat. No. 2,549,846 and such compositions comprise a crystallographic phase of CeO₂ type... and corresponding to the formula Ln_{2.x}Ce_xSi₂OTin which..., x is greater than or equal to 0 and less than 2" (column 5, lines 7-15). The aforementioned further reads on, a solution comprising particles dispersed in a medium, wherein; the particles comprise as a main component crystalline cerium oxide of the cubic system and as an additional component a lanthanum compound, neodymium compound or a combination thereof; and the additional component is contained in an X/ (Ce + X) molar ratio of 0.005 to 15 in which X is lanthanum atoms, neodymium atoms or a combination thereof.

The aforementioned also reads on, an abrasive comprising a sol including particles dispersed in an aqueous medium, wherein; the particles comprise as a main component crystalline cerium oxide of cubic system and as an additional component a lanthanum compound, neodymium compound or a combination thereof; the additional component is contained in an X/(Ce + X) molar ratio of 0.005 to 0.15 in which X is lanthanum atoms, neodymium atoms or a combination thereof, *in claims 19 and 22*; wherein the additional component is a lanthanum compound, *in claims 20 and 23*; wherein the additional component is a neodymium compound, *in claims 21 and 24*; and Tastu differs in failing to teach a particle size of 2 to 200 m²/g, *in claims 19 and 22*.

Ashley discloses a stable ceria composition of one or more of La, Nd or Y and the stabilized ceria retains a surface area of greater than 20 m²/g (Abstract), which encompasses a particle having a specific surface area of 2 to 200m²/g. Since Ashley illustrates the specific combination of particles having a surface area of 2 to 200 m²/g is known, then it would have been obvious to one having ordinary skill in the art at the time the invention was made to select any range of surface area as taught by Ashley, including Applicants' specifically claimed range of surface area for the purpose of forming a high surface area ceria composition by incorporating one or more of La or Nd to the composition (Ashley, Abstract).

Tastu discloses the pH of the reaction medium 5-10 (column 5, lines 59-64, column 8, lines 5-7) but does not explicitly cite the use of reaction medium with pH less than 5. However, Sakatani discloses the abrasive composition with abrasive particles e.g. cerium oxide or aluminum oxide or silicon oxide (claim 1) with pH of about 5 or less

(claims 10 and 14, and column 3, lines 61-65). Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention was made to select the pH range less than 5 in the slurry composition employed by Tastu because Sakatani illustrates that the pH of the slurry depends on the kind and amount of an oxidizing agent added to the slurry composition to maintain stability of the oxidizing agent (col.3, lines 66-67 and col.4, lines 1-2).

Tastu in view of Ashley differs in failing to teach a solution wherein the particles have a particle size of 50 to 150 nm, *in claims* 19 and 22.

Aozasa teaches, "... a cerium solution having an average colloidal particle size of 3 to 100 nm, and optionally one or more members selected from the group consisting of salts of yttrium, scandium, lanthanum, praseodymium, neodymium, samarium, europium, gadolinium, magnesium, calcium, barium, aluminum, titanium, and hafnium. • ." (column 3, lines 49) and "... a cerium solution having an average colloidal particle size of 3 to 100 nm, preferably 5 to 80 nm, more preferably 10 to 50 nmIf the average colloidal particle size is smaller than 3 nm, production in industrial scale will be difficult (column 5, lines 52-59). Aozasa also teaches, cerium sol having a concentration of about 100 to 200 g/liter (~10 to 20 g/100 ml or 10-20 wt %), (column 6, lines 4-6).

It would have been obvious to one having ordinary skill in the art at the time of the claimed invention to modify the combination or abrasive materials as taught by Tastu in view of Ashley, by using Aozasa's sol having a particle size of 3 to 100 nm which falls within the particle size range as claimed by applicants for the purpose of ease of production on an industrial scale (Aozasa, column 8, lines 42-45).

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Tastu in view of Ashley and Aozasa differ in failing to teach an abrasive for polishing a substrate comprising silica in an amount of 50 wt% or more, an abrasive for polishing a rock crystal, a quartz glass for a photomask, a semiconductor device or a hard disk made of glass, *in claim 19*; and an abrasive for polishing an organic film with the Chemical Mechanical Polishing method, an Inter Layer Dielectric (ILD), or a shallow trench isolation of a semiconductor device, *in claim 22*.

Since the combination of Tastu in view of Ashley and Aozasa teaches Applicants' specifically claimed abrasive, then using the said combination in the same manner as claimed by Applicants would result the same in an abrasive for polishing a rock crystal, a quartz glass for a photomask, a semiconductor device or a hard disk made of glass; an organic film with the Chemical Mechanical Polishing method, an Inter Layer Dielectric (ILD), or a shallow trench isolation of a semiconductor device; and an organic film with the Chemical Mechanical Polishing method, an Inter Layer Dielectric (ILD), or a shallow trench isolation of a semiconductor device.

As to claims 25 and 26, Tastu is silent about a solution that includes a water soluble polymer, an anionic surfactant, a nonionic surfactant and a cationic surfactant. However, Brancaleoni discloses the use of a solution that includes surfactant compounds e.g. non-ionic, anionic, cationic or amphoteric surfactants (col.5, lines 16-20). Therefore, it would have been obvious to one of ordinary skill in the art at the time the invention was made to use surfactant in the composition because Brancaleoni illustrates that surfactant compounds may provide an anti-scratching effect on the

Response to Arguments

4. Applicant's arguments filed on 3/3/2010 have been fully considered but they are not persuasive.

Applicants' arguments on page 4-5 of the reply with respect independent claims 19 and 22 asserting that the reference of Tastu, does not meet the pH limitations of these claims are not convincing. Tatsu describes a solution of the salt or salts of the rare earth or earths which is added continuously to the reaction medium in parallel with the basic solution (col.8, line 15-23) to achieve a pH that is greater than 5 but less than 10 (col.8, lines 3-7), therefore encompasses the range cited in independent claims 19 and 22. Tastu discloses that the polishing composition could be in the form of an aqueous suspension (col.5, lines 60-65, col.9, lines 21-23) or in the powder form (col.9, lines 28-30) and leads to a stable composition (col.10, lines 33-41) as illustrated in Examples 1-8 (cols.12-14) and with pH in the range of about 5-10 (col.3, lines 59-64, col.5, lines 60-65, claim 24). However, newly added reference of Sakatani (US Patent No. 5,804,513) discloses the slurry composition with pH less than 5.

Applicants' arguments on page 6 of the reply asserting that the pH disclosed by the reference of Tastu is for an intermediary reaction mixture and not a final abrasive are not convincing. Tastu discloses the process of introducing cerium into the reaction medium in the cerous state and is then oxidized to the ceric state and hence controlling the pH of the reaction medium (col.3, lines 31-64). The chemical composition of

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cerium-based polishing composition that includes cerium oxide is illustrated in

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Examples 1-8 and claim 17. Therefore, the combined teachings of Tastu, Ashley,

Aozasa, Brancaleoni and Sakatani would meet the limitations of independent claims 19

and 22.

Conclusion

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to MAKI A. ANGADI whose telephone number is (571)272-

8213. The examiner can normally be reached on 8 AM to 4.30 PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Nadine G. Norton can be reached on 571-272-1465. The fax phone number

for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the

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USPTO Customer Service Representative or access to the automated information

system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/Nadine G Norton/ Supervisory Patent Examiner, Art Unit 1792 /Maki A Angadi/ Examiner, Art Unit 1792 Application/Control Number: 10/015,675

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